

T493D337K006CT6110

T493 HRA, Tantalum, MnO2 Tantalum, HRA, 330 uF, 10%, 6.3 VDC, SMD, MnO2, Molded, High Reliability, C (0.01%/1000 Hrs), 500 mOhms, 7343, 3.1 mm, 1.3 mm

CATHODE (-) END VIEW



ANODE (+) END VIEW

BOTTOM VIEW Give pad shape/design at KEETs option

SIDE VIEW

Click here for the 3D model.

General Information	
Series	T493 HRA
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, MnO2, Molded, High Reliability
Features	High Reliability
RoHS	Yes
Termination	Tin
AEC-Q200	No
Typical Component Weight	412.33 mg
Notes	P and R dimensions represents the minimum solderable area of the termination surface entirely below cutout (if one is present).

Dimensions	
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
н	2.8mm +/-0.3mm
Т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
В	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
Р	0.5mm MIN
R	1mm REF
Х	0.1mm +/-0.1mm REF

Packaging Specifications	
Packaging	T&R, 178mm
Packaging Quantity	500

Specifications	
Capacitance	330 uF
Tolerance	10%
Voltage DC	6.3 VDC (85C), 4.22 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	8% 120Hz 25C
Failure Rate	C (0.01%/1000 Hrs)
ESR	0.5 Ohms (100kHz 25C)
Ripple Current	548 mA (rms, 100kHz 25C)
Leakage Current	20.8 uA (5min 25°C)
Testing and Reliability	Standard Testing Only

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